PATENT APPLICATION

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Tanya Jegeris Snyder, et al. Serial No.: Not Yet Assigned Examiner: Vu, Quang D. Filing Date: 6/13/2003 Group Art Unit: 2811 Title: Wafer Bonding Using Reactive Foils For Massively Parallel Micro-Electromechancial System Packaging **COMMISSIONER FOR PATENTS** PO Box 1450 Alexandria, VA 22313-1450 PRELIMINARY AMENDMENT Sir: Please amend the above-identified application as follows: Page 1, line 1, insert the following new paragraph: () This is a Continuation of copending application Serial No. , filed on , the entire disclosure of which is incorporated herein by reference. (X) This is a Divisional of copending application Serial No. 10/461,291 , filed on 6/12/2003 , the entire disclosure of which is incorporated herein by reference. In the Claims: Cancel the following claims 1-19, 24-25 of the prior application. (At least one original claim must be retained for filing purposes). "Express Mail" label no. EK176606861US Respectfully submitted, Date of Deposit 4-15-04 Tanya Jegeris Snyder, et al. I hereby certify that this is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on Judy Liao Shie the date indicated above and is addressed Commissioner for Patents, PO Box 14 Commissioner for Patent Alexandria, VA 22313-1450-Patents, Attorney/Agent for Applicant(s) Reg. No. 50,305

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